

C1825X562KFGACTU

Aliases (C1825X562KFGAC7800)

SMD Comm COG HV Flex, Ceramic, 5,600 pF, 10%, 1,500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1825, 2.3 mm



Click [here](#) for the 3D model.

General Information

Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	310 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	5,600 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1,800 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

Dimensions

Chip Size	1825
L	4.6mm +/-0.4mm
W	6.4mm +/-0.4mm
T	2.5mm +/-0.20mm
S	2.3mm MIN
B	0.7mm +/-0.35mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.